EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	221	257/666,667,672,673,675,787.ccls. and (semiconductor with (encapsul$4 or mold$3) and land and lead adj frame)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 12:59
S2	0	"60594859".ap.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 12:59
S3	6	("5969426" | "6215179" | "6247229" | "6278177" | "6294830" | "6309909").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 13:41
S4	8	("5285352" | "5355283" | "5371404" | "5394009" | "5450283" | "5461197" | "5554887" | "5619070").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 13:54
S5	237	"257".clas. and ((plurality near3 (ball or sphere or bump) with seal$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 15:17
S6	0	"9990083"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 16:35
S7	0	("9990083").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/08/01 16:35
S8	0	"9990083".ap.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 16:35

S9	0	"09990083".ap.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 16:37
S10	0	(method adj2 apparatus adj2 leadframe adj based adj grid adj array adj ic adj packaging).ti.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 16:38
S11	1	(method adj2 apparatus adj2 lead-frame adj based adj grid adj array adj ic adj packaging).ti.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 16:51
S12	2	("20020168796").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/08/01 17:10
S13	2	"6670222".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 17:26
S14	0	("jp2004-71898").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/08/01 17:26
S15	0	("jp200471898").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/08/01 17:26

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S16	0	jp200471898.pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 17:27
S17	0	"200471898".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 17:27
S18	0	("2004-71898.pn.").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/08/01 17:27
S19	0	jp2004-71898.pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 17:29
S20	2	("20020168796").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/08/01 18:54
S21	2	"5969426".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 18:56
S22	0	"257".clas..and (heat adj sink) and (passive adj device) and (thickness with chip adj attach$4 adj site)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 18:58

S23	0	"257".clas. and (thickness with chip adj attach$4 adj site)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 18:58
S24	86	"257".clas. and (thickness with chip adj attach$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 19:00
S25	1	"257".clas. and (distance with semiconductor near3 (routing adj circuit))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 19:02
S26	1	distance with semiconductor near3 (routing adj circuit)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 19:03